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Kent E. Genin, Reg. No. 37,834

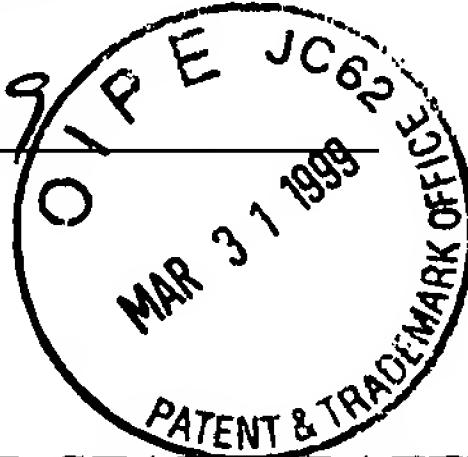
Name of Applicant, assignee or Registered Representative

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Date of Signature

Kent E. Genin

3/29/99



**Response Under 37 CFR 1.116
Expedited Procedure
Examining Group 3723**

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Group 3700

*# 12pmd+E
(NE)
4/21/99*

**PATENT
CASE NO. 7103/30**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Homayoun Talieh et al.

Serial No.: 08/853,323

Filed: May 8, 1997

For: LINEAR POLISHER AND
METHOD FOR
SEMICONDUCTOR WAFER
PLANARIZATION

Examiner: G. Nguyen

Group Art Unit: 3723

AMENDMENT UNDER 37 C.F.R. §1.116

Assistant Commissioner for Patents
Box AF
Washington, D.C. 20231

Dear Sir:

In response to the final Office Action dated January 27, 1999 please enter the following amendment and consider the following remarks:

IN THE CLAIMS:

Please amend claims 32, 34, 36-38, and 40 as follows: